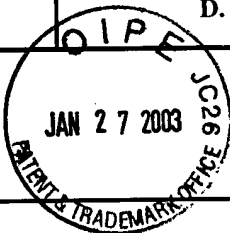
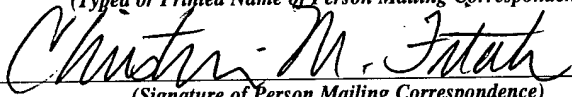


2827

CERTIFICATE OF MAILING BY FIRST CLASS MAIL (37 CFR 1.8)			Docket No. TSL1549	
Applicant(s): Yamakawa, et. al.				
Serial No. 09/597,218	Filing Date June 20, 2000	Examiner D. Graybill	Group Art Unit 2827	
Invention: Adhesive and Semiconductor Devices				
				
<p>I hereby certify that this <u>Response to Office Action Rejection</u> <i>(Identify type of correspondence)</i></p> <p>is being deposited with the United States Postal Service as first class mail in an envelope addressed to: The Assistant Commissioner for Patents, Washington, D.C. 20231 on <u>January 21, 2003</u> <i>(Date)</i></p> <p style="text-align: right;"><u>Christine M. Fitak</u> <i>(Typed or Printed Name of Person Mailing Correspondence)</i>  <i>(Signature of Person Mailing Correspondence)</i></p> <p style="text-align: center;">Note: Each paper must have its own certificate of mailing.</p>				

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	Yamakawa, et al.	: Examiner:	Graybill, D.
Title:	Adhesive and Semiconductor Devices	: Reply under 37 C.F.R. §1.113	
Serial No.:	09/597,218	: Art Unit:	2827
Filed:	20 June, 2000	: Confirmation No.:	5276
Docket No.:	TSL 1549	: Date:	21 January, 2003

Assistant Commissioner for Patents
Washington, DC 20231

Sir:

In response to the Office Action dated 5 December 2002, the applicants request reconsideration based on the following remarks.